

CHO SEAL 1221 and 1224

Silver Filled for Highest Shielding Effectiveness

Customer Value Proposition:

CHO SEAL Aerospace-200 grade sheet stock materials are highly conductive elastomers which provide both RF suppression and pressure retention. These materials consist of essential silver powders dispersed in silicone or fluorosilicone binders. They are resilient, homogenous composites manufactured from components of the highest quality and are also available in die-cut and moulded shapes. Aerospace-200 grade materials are characterised by exceptional heat stability, maintaining their electrical properties at continuous use temperatures up to 200°C. They also meet NASA out-gassing specifications. Variations in chemical or physical properties make each material in this grade specifically suited for certain applications.

CHO SEAL 1221 Fluorosilicone intended for use where solvent, oil, or jet-fuel compatibility is required.

CHO SEAL 1224 Medium durometer silicone material.

CHO SEAL conductive elastomers are chemically inert and will resist the effects of most corrosive atmospheres.

Where silver filled CHO SEAL materials are in contact with dissimilar metals in a corrosive environment, coating or edge sealing of the mating surfaces may be required. (For best corrosion resistance Cho Seal 6502, 6503, 1285, 1287 and 1298 are recommended)

CHO SEAL products are not nutrients for fungus or micro-organisms, and will not support their growth. They are moisture resistant, even at high temperatures.



Aerospace 200 grade sheet stock is available in standard thicknesses of 0.51mm, 0.81mm, 1.14mm, 1.57mm, 2.36mm and 3.18mm.

Unique advantages over other methods of EMI shielding and sealing include:
HEAT STABILITY. When used within the recommended range of continuous-use temperatures. Cho Seal Aerospace 200 grade materials provide reliable shielding and sealing.

REUSEABILITY. They retain their original shape if compressed within recommended limits.

NON SCARRING. They contain no metal wires or knurled surfaces to break or scar mating flanges.

CONFORMABILITY. They conform to uneven or rough surfaces.

SPECIFICATIONS	Test	Cho Seal	Cho Seal
	Procedure	1224	1221
Type (Ref MIL-G-83528)		Type E	Type F
Elastomer Binder		Silicone	Fluorosilicone
Conductive Filler		Silver	Silver
Volume Resistivity (ohm-cm, max) as supplied (without psa)	MIL-G-83528 Para 4.6.11	0.002	0.002
Durometer (Shore A +/-5)	ASTM D2240	65	75
Specific Gravity (+/-0.25)	ASTM D792	3.4	4.0
Tensile Strength (psi. min)	ASTM D412	300	250
Elongation (% min. max)	ASTM D412	200 / 500	100 / 300
Tear Strength (lb / in. min)	ASTM D624	60	40
Compression Set 70 hours @100°C (% , max)	ASTM D395 Method B	45	60
Low Temperature Flex TR10 (°C, min)	ASTM D1329	-65	-65
Maximum Continuous Use (°C)		160	160
Maximum Intermittant Use (°C)		200	200
Thermal Conductivity W/m-K	ASTM D 5470 Method B	2.8	NA
SHIELDING EFFECTIVENESS (dB min)			
200 kHz (H Field)		70	70
100 MHz (E Field)		120	120
500 MHz (E Field)	MIL-G-83528	120	120
2.0 GHz (Plane Wave)	Para 4.6.12	120	120
10.0 GHz (Plane Wave)		120	120
ELECTRICAL STABILITY (ohm-cm, max)			
HEAT AGING	MIL-G-83528	0.010	0.010
	During	MIL-G-83528	0.010
	After	Para 4.6.13	0.002
Vibration Resistance	Para 4.6.9	0.010	0.010
Post Tensile Set Volume Resistivity	MIL-G-83528	0.010	0.010
EMP Survivability (kA per in. perimeter)	MIL-G-83528 Para 4.6.16	>0.9	>0.9

* Compression set is expressed as a percentage of deflection per ASTM D395 Method B at 25% deflection. To determine percent recovery, subtract 0.75 of stated compression set value from 100%. For example, in the case of 30% compression set, recovery is 92.5%

**Where two values are shown, the first represents maximum operation temperature for conformance to MIL-G-83528 (Which requires Group A life testing at 1.25 times maximum operation test) Second value represents practical limits for exposure up to 1000 hours (compressed between flanges 7-10%)

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